



Issue No. : WLPSMD252010F-131001-A
Date of issue :
Classification : New Changed Revised

PRODUCT SPECIFICATION FOR APPROVAL

Brand : WIWINTECH
Customer :
Customer P/N :
Product Description : Molding Power Choke -- High Current Type
2.5±0.2 m/m × 2.0±0.2 m/m H : 1.0 m/m Max
Part Name : WLPSMD252010F-S Series
Date : OCT.01.2013
Term of Validity : SEP.30.2018 from the day of issue

REMARK:		
Customer Approval Feedback		

Prepared by: Product Engineering Service Section Engineering Department		
Approved	Checked	Designed
David Zhou	Sean Lu	Jimmy Sung

[SPECIFICATION]

[ALLOY MOLDING POWER CHOKE] (WLPSMD252010F-S)

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- *All the materials used in this product are registered material under the Law Concerning the Examination and Regulation of Manufacture, etc. of Chemical Substances.
- *This product has not been manufactured with any ozone-depleting chemical controlled under the Montreal Protocol.
- *All the materials used in this product contain no brominated materials of PBBOs or PBBs as the flame-retardant.
- * "The Term of Validity" of Product Specifications for Information Unless otherwise requested (including from customer), the term of validity shall be renewed automatically. Then, information and specifications shall be not issued.

1. SCOPE

This specification covers the Multilayer Chip Inductors Ferrite to be delivered to.

2. PART NUMBER OF PRODUCTS

This part number of the products in this specification shall be WLPSMD252010F-S Series.

3. TEST CONDITIONS

The ambient temperature shall be 5°C to 35°C and the relative humidity 35% to 85%, unless otherwise specified. When the test result is doubtful, the sample in question shall be tested again at 20±2°C, 65±5%RH.

4. APPEARANCE DIMENSIONS AND CONSTRUCTION

Inductors shall be free from distortion, damage, contaminants, whysker and shall be within dimensions specified.

5. ELECTRICAL CHARACTERISTICS

As specified in the electrical characteristics table.

6. RELIABILITY CHARACTERISTICS

As specified in the reliability characteristics table.

7. PACKAGE

The products shall be packed so as not allow absorption damage.

8. OPERATING TEMPERATURE

- 40°C ~ + 125°C

9. OTHERS

The customer is requested to store the products at the normal temperature (-5~35°C) and the normal humidity (85%RH max.) in the packages we supplied.

The package shall not be exposed to direct sunlight and harmful gas and care should be taken so as not to cause dew.

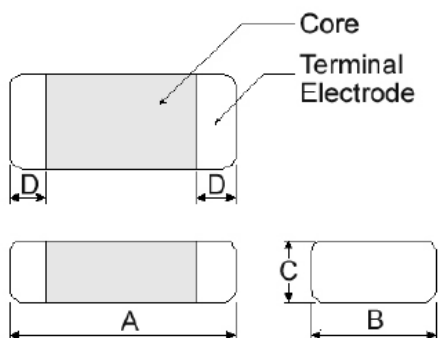
No.	Date	Revision	Check
APPROVAL		CHECK	DESIGN
David Chao		Sean Lu	Jimmy Sung

[SPECIFICATION]

[ALLOY MOLDING POWER CHOKE] (WLPSMD252010F-S)

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■ Apperance Dimentions and Construction



RoHS

Halogen
Free

Unit : m/m

A	B	C	D
2.50±0.20	2.00 ± 0.20	1.00 MAX	0.60 ± 0.30

■ Part Number

W	LP	S	M	D	2520	10	F	1R0	M	—	S
(1)	(2)	(3)	(4)	(5)	(6)	(7)	(8)	(9)	(10)		

- (1) Brand Code : W
- (2) Product Code : Power Inductor
- (3) Shielded construction : S
- (4) Molding Type : M
- (5) Series Code : High Current : D
- (6) Size Code : Dimentions : $2.5 \pm 0.2 \times 2.0 \pm 0.2$ m/m
- (7) Hight: 1.0 m/m MAX
- (8) Material Code : F
- (9) Inductance Code:United is uH and 3 digits are used

860nH=R86 3.3uH=3R3

47μH=470 220uH=221

- (10) Tolerance Code: K: ±10% M: ±20% N: ±30%

[SPECIFICATION]

[ALLOY MOLDING POWER CHOKE] (WLPSMD252010F-S)

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Part No.	Inductance (μ H) $\pm 20\%$	Test Condition	RDC ($m\Omega$)		Isat (A)		Irms (A)	
			Typ	Max	Typ	Max	Typ	Max
WLPSMD252010FR47M-S	0.47	2MHz / 0.2V	34	44	6.60	5.30	3.80	3.30
WLPSMD252010FR68M-S	0.68	2MHz / 0.2V	47	62	5.20	4.00	3.50	3.10
WLPSMD252010F1R0M-S	1.0	2MHz / 0.2V	57	74	4.50	3.60	3.20	2.70
WLPSMD252010F1R5M-S	1.5	2MHz / 0.2V	78	101	4.20	3.40	3.00	2.40
WLPSMD252010F2R2M-S	2.2	2MHz / 0.2V	124	149	3.30	2.80	1.95	1.60

■ Note

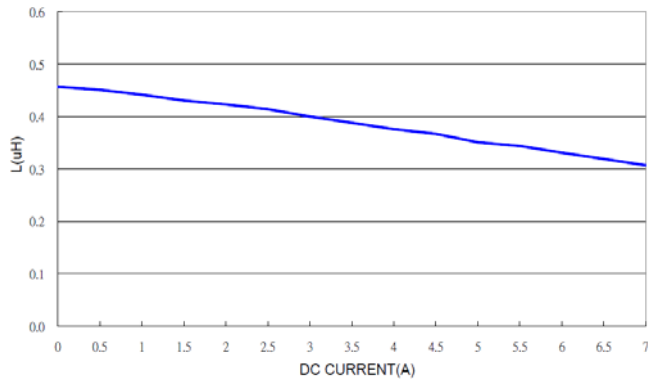
- (1) Irms DC current (A) that will cause an approximate ΔT of 40°C.
- (2) Isat DC current (A) that will cause L to drop approximately 30%
- (3) L : Agilent/HP4287A+16197A, 1MHz 500mV
- (4) RDC : HP 4338B, or equivalent
- (5) Operating temperature range from -40°C to 125°C. (Including self - temperature rise)

[SPECIFICATION]

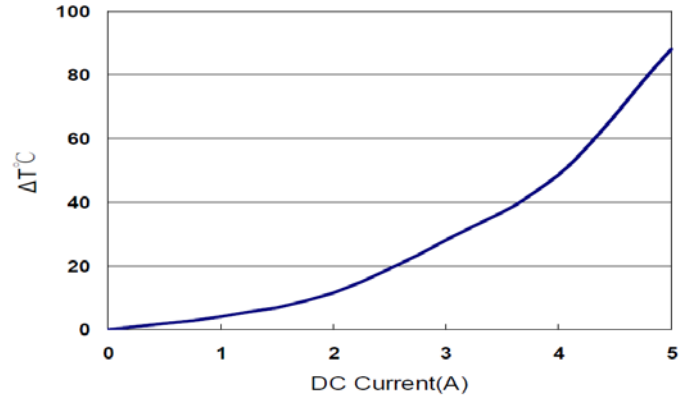
[ALLOY MOLDING POWER CHOKE] (WLPSMD252010F-S)

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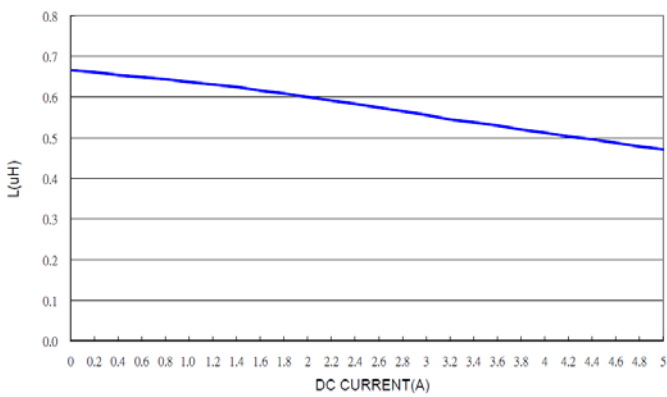
Inductance vs. DC Characteristics
WLPSMD252010FR47M-S



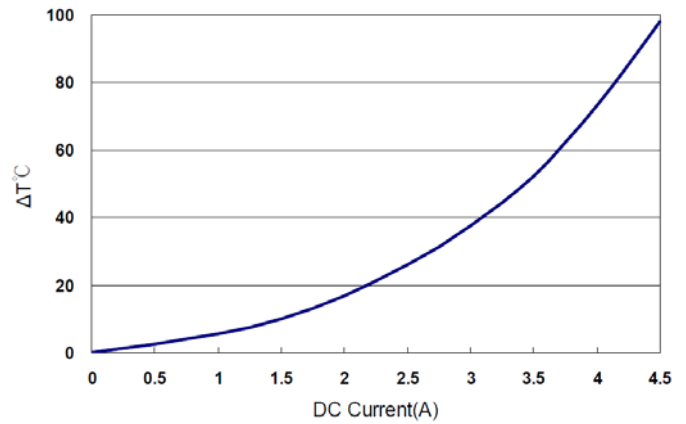
Temp. vs. DC Current
WLPSMD252010FR47M-S



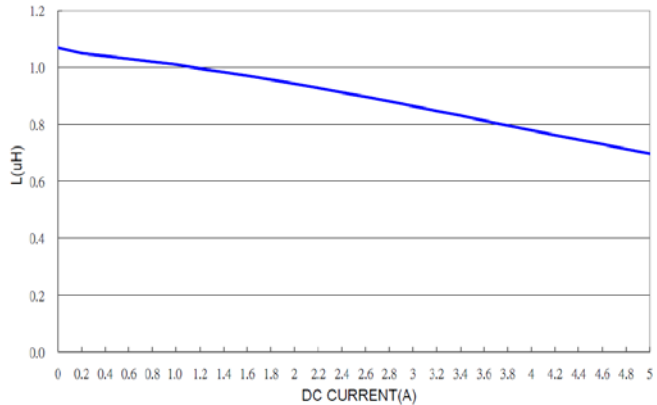
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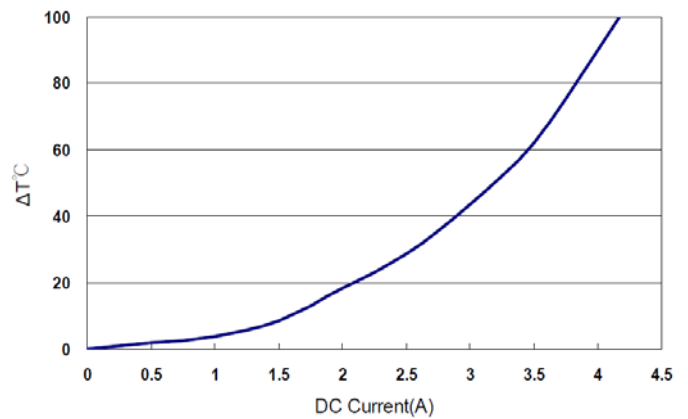
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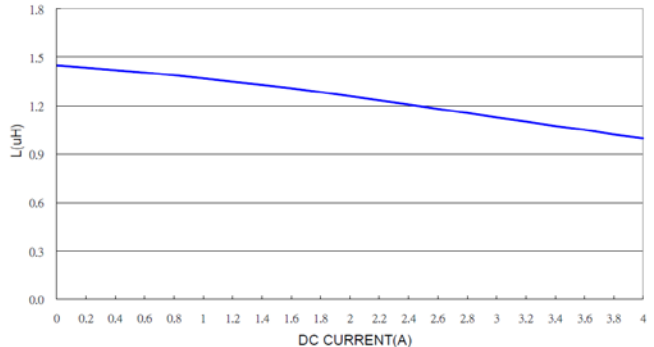
WLPSMD252010F1R0M-S



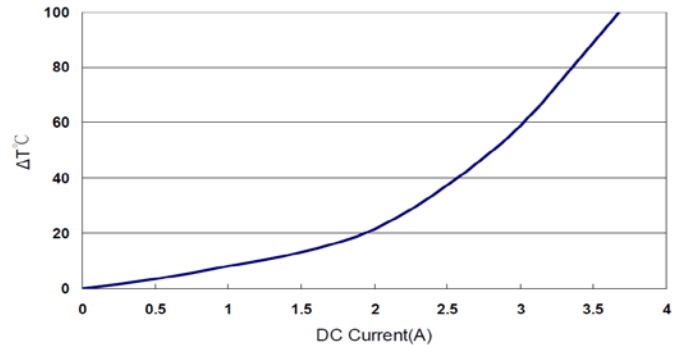
WLPSMD252010F1R0M-S



WLPSMD252010F1R5M-S



WLPSMD252010F1R5M-S



Temperature test conditions: 1. Start as the atmosphere temp. @25°C.

2. Take the reading once it becomes stable.

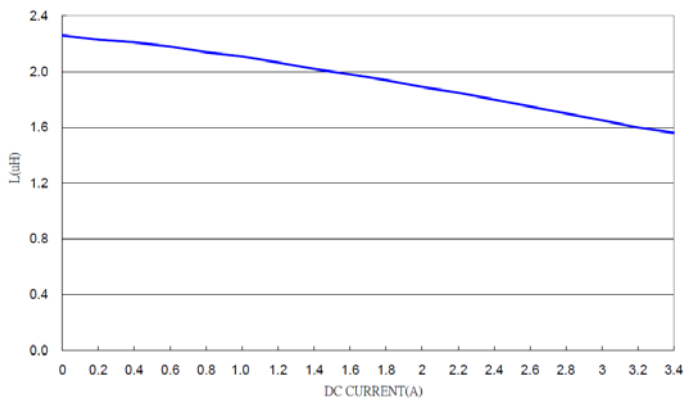
3. Need to wait 90Sec at least, then change to the next applied current value.

[SPECIFICATION]

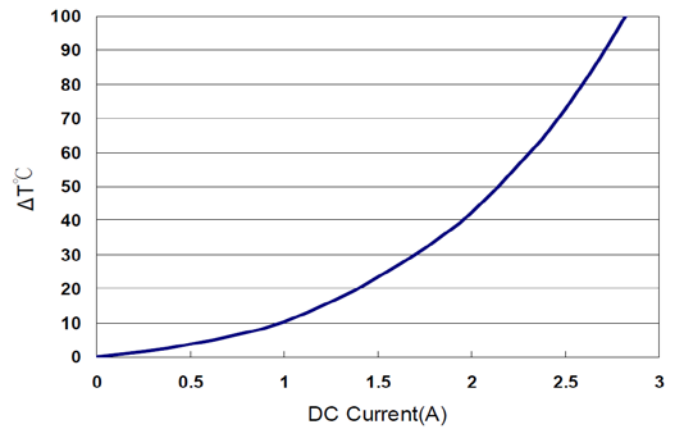
[ALLOY MOLDING POWER CHOKE] (WLPSMD252010F-S)

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■ Inductance vs. DC Characteristics
WLPSMD252010F2R2M-S



■ Temp. vs. DC Current
WLPSMD252010F2R2M-S



- Temperature test conditions:
1. Start as the atmosphere temp. @25 $^{\circ}C$.
 2. Take the reading once it becomes stable.
 3. Need to wait 90Sec at least, then change to the next applied current value.

[SPECIFICATION]

[ALLOY MOLDING POWER CHOKE] (WLPSMD252010F-S)

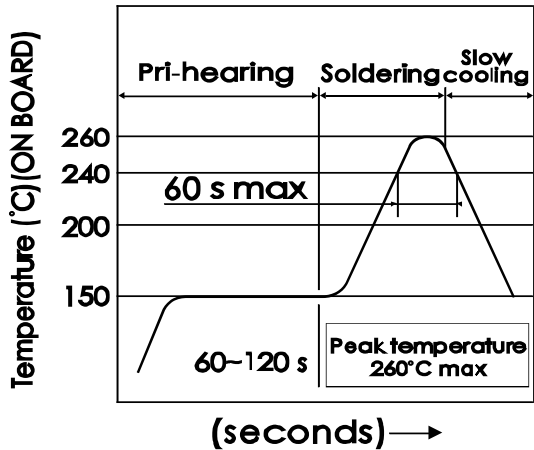
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ITEM	SPECIFICATION	TEST METHOD/CONDITION
DIELECTRIC STRENGTH	Without damage	100V DC shall be applied for 60s between the terminal and the core
INSULATION RESISTANCE	100MΩ or more	100V DC shall be applied between the terminal and the core
TEMPERATURE CHARACTERISTICS	Must be satisfy electrical characteristics	-40~+125°C Standard: Values at 20°C
HUMIDITY CHARACTERISTICS	*There shall not be case deformation or change in appearance. *Variation of inductance shall be within ±3%. *Must be satisfy electrical characteristics	Inductors shall be stored to 90~95%RH at 60±2°C for 500±8 hours. Measurements shall be made after 1 hour stabilization at room temperature.
HEAT RESISTANCE		Inductors shall be stored to 85±2°C for 500±8 hours. Measurements shall be made after 1 hour stabilization at room temperature.
THERMAL SHOCK		Inductors shall be stored 100 times to the following temperature cycle. 1. -40°C, 30 minutes 2. +85°C, 30 minutes Measurements shall be made after 1 hour stabilization at room temperature.
LOW TEMPERATURE STRAGE		Inductors shall be stored to -40+2°C for 500±8 hours. Measurements shall be made after 1 hour stabilization at room temperature.
HIGH TEMPERATURE LOAD LIFE	*There shall not be case deformation or change in appearance. *Variation of inductance shall be within ±3%. *Must be satisfy electrical characteristics	With rated current applied. Indicators shall be stored at 85±2°C for 500±8 hours. Measurements shall be made after 1 hour stabilization at room temperature.
HUMIDITY LOAD LIFE		With rated current applied. Indicators shall be subjected to 90~95%RH at 60±2°C for 500±8 hours. Measurements shall be made after 1 hour stabilization at room temperature.

[SPECIFICATION]

[ALLOY MOLDING POWER CHOKE] (WLPSMD252010F-S)

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ITEM	SPECIFICATION	TEST METHOD/CONDITION
Resistance To Soldering Heat	<p>There shall not be case deformation or change in appearance.</p> <p>Variation of inductance shall be within $\pm 5\%$.</p>	<p>The coil shall be passed through the reflow furnace with the condition shown in profile below for 2 times. And then the coil shall be subjected to standard atmospheric conditions for 1 to 2 hours after which measurement shall be made.</p> <p>For other procedures, refer to IEC Pub. 68-20, Test Tb.</p> <p>A temperature does a temperature on a board.</p>  <p>The graph shows a temperature profile for reflow soldering. The y-axis is labeled 'Temperature (°C) (ON BOARD)' with values 150, 200, 240, and 260. The x-axis is labeled '(seconds) →'. The profile starts at 150°C, rises to a plateau at 240°C for a duration of '60-120 s'. This is followed by a 'Pri-heating' phase, then a 'Soldering' phase where the temperature rises to a 'Peak temperature 260°C max'. The final phase is 'Slow cooling'.</p>
Vibration	<p>There shall not be case deformation or change in appearance.</p> <p>Variation of inductance shall be within $\pm 5\%$.</p>	<p>Only endurance conditioning by a frequency sweep shall be made. The entire frequency range, from 10 to 55Hz and return to 10Hz, shall be traversed in 1 minute.</p> <p>Amplitude (total excursion) : 1.5mm</p> <p>This motion shall be applied for a period of 2 hours in each of 3 mutually perpendicular directions (a total of 6 hours).</p>
Shock		<p>Pulse shape : Half sine</p> <p>Peak acceleration : 981m/s² (100G)</p> <p>Duration of the pulse : 6ms</p> <p>Three successive shocks shall be applied in both directions of 3 mutually perpendicular axis (a total of 6 hours).</p>
Terminal Pull Strength	<p>There shall not be case deformation or change in appearance.</p> <p>There shall be no evidence of intermittent contact or open circuiting.</p>	<p>A 4.9N load shall be applied to both terminals in the horizontal direction for 1±0.05 minutes.</p>
Resistance To Solvents	<p>There shall not be case deformation or change in appearance.</p>	<p>Inductors shall be stored to ISOPROPYL-ALCOHOL for 10 minutes respectively.</p>

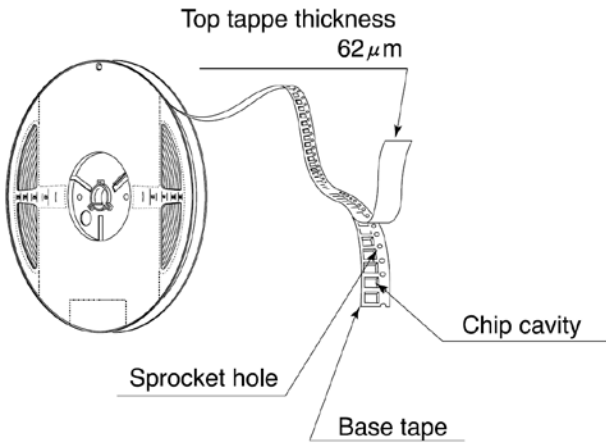
[SPECIFICATION]

[ALLOY MOLDING POWER CHOKE] (WLPSMD252010F-S)

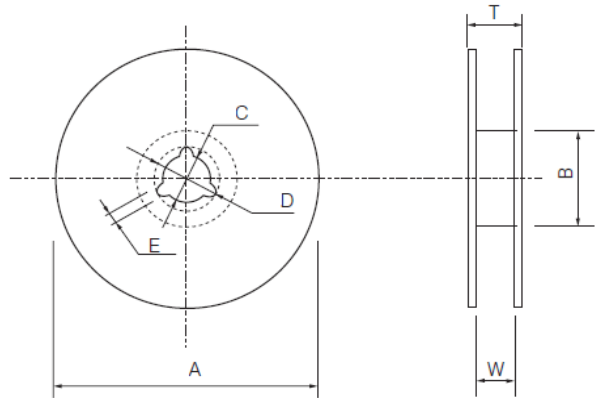
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■ Packing

• Reel size



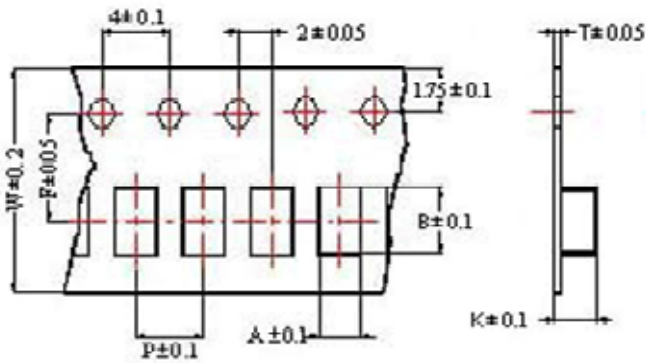
• Reel Dimensions



Unit : mm

A	B	C	D	E	W	T
180.0±3.0	60.0±1.0	13.0±0.5	21.0±0.8	2.0±0.5	9.0±0.3	11.4±1.5

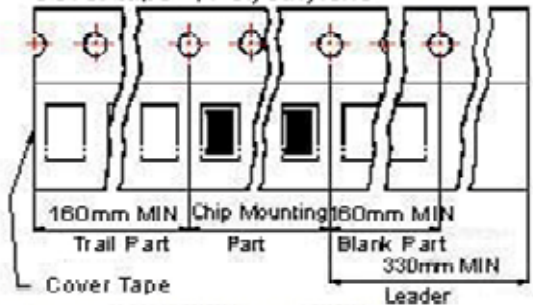
• Taping Dimensions



Tape Material

Carrier tape : Polycarbonate

Cover tape : Polyethylene



Unit : mm

A	B	T	W	P	F	K
2.25	2.80	0.25	8	4	3.5	1.15

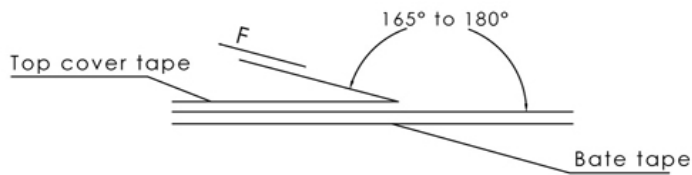
Reel		5 Reel / Box	
Q'ty(Pcs)	Size m/m	Q'ty(Pcs)	Size m/m
3,000	180 φ	15,000	365x365x90

[SPECIFICATION]

[ALLOY MOLDING POWER CHOKE] (WLPSMD252010F-S)

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■ Tearing Off Force



The force for tearing off cover tape is 15to 60 grams in the arrow direction under the following conditions.

Room Temp. (°C)	Room Humidity (%)	Room atm (hPa)	Tearing Speed mm/min
5~35	45~85	860~1060	300

Application Notice

• Storage Conditions

To maintain the solderability of terminal electrodes:

1. Temperature and humidity conditions: Less than 40°C and 70% RH.
2. Recommended products should be used within 6 months from the time of delivery.
3. The packaging material should be kept where no chlorine or sulfur exists in the air.

• Transportation

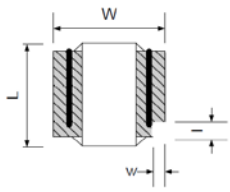
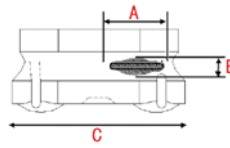
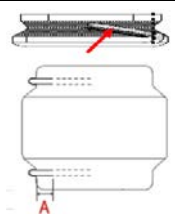
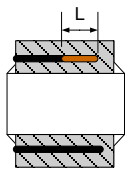
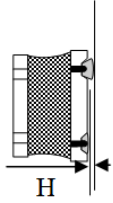
1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
3. Bulk handling should ensure that abrasion and mechanical shock are minimized.

[SPECIFICATION]

[ALLOY MOLDING POWER CHOKE] (WLPSMD252010F-S)

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■ Tearing Off Force

No.	Defect Item	Graphic	Rejection identification	Acceptance
1	Core defect		$L > L/6$ or $w > W/6$, NG.	AQL=0.65
2	Void appearance tolerance limit		Size of voids occurring to coating resin is specified below. ① Width direction (dimension A): Acceptable when $A \leq C/2$ Nonconforming when $B \geq C/2$ ② Length direction (dimension B): Dimension b is not specified. ③ When total area of voids (including one exposing coil) occurring to each sides is not greater than 50% of coating resin area, that is acceptable.	AQL=0.65
3	External appearance criterion for exposed wire		Exposed end of the winding wire at the secondary side should be 1.5mm and below. ① Acceptable when $A \leq 0.6\text{mm}$ ② Nonconforming when $A > 0.6\text{mm}$	AQL=0.65
4	Cold solder		L more than 1 mm, NG.	AQL=0.65
5	Solder uneven		$H > 0.1\text{mm}$. NG.	AQL=0.65

[SPECIFICATION]

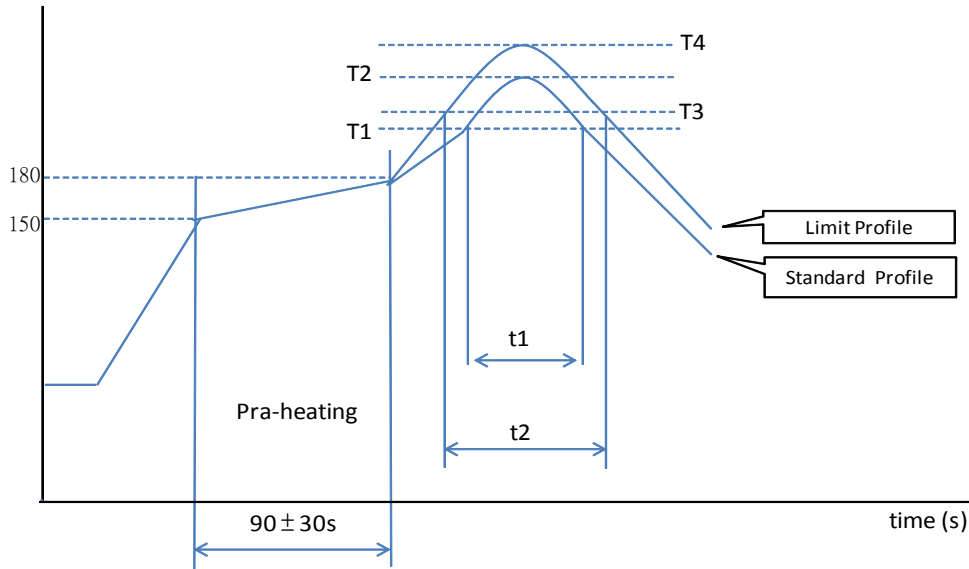
[ALLOY MOLDING POWER CHOKE] (WLPSMD252010F-S)

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ITEM

CONTENTS

Reflow
Soldering
Profile



Standard Profile				Limit Profile			
Heating		Peak temperature (T2)	Cycle of reflow	Heating		Peak temperature (T4)	Cycle of reflow
Temp.(T1)	Temp.(t1)			Temp.(T3)	Temp.(t2)		
220°C	30 to 60s	245±3°C	2 times max.	230°C	60s max.	260°C/10s	2 times max.
220°C	30 to 60s	245±3°C	2 times max.	230°C	60s max.	260°C/10s	1 times

The following conditions must be strictly followed when using a soldering iron.

Pre-heating	150°C, 1min
Tip temperature	350°C max.
Soldering iron output	80W max.
Tip diameter	φ3mm max.
Soldering time	3(+1,-0)s
Times	2 times

Note1 : The measurement shall be made after the samples are left in normal temperature and normal humidity for 1 hour in both cases.

Note2 : Do not directly touch the products with the tip of soldering iron in order to prevent the crack on the products due to the thermal shock.

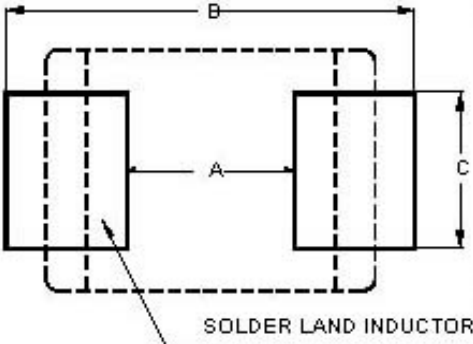
[SPECIFICATION]

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PRECAUTION FOR USE OF POWER INDUCTOR

ITEM	CONTENTS
RESOLDERING WITH A SOLDERING IRON	<p>The temperature of the soldering iron should be 390°C or less, 5seconds.</p> <p>And resoldering with a soldering iron should be limited to 1time, and after that should be cooling these.</p> <p>Do not touch the resist of grip inductor with the tip of the soldering iron.</p>

RECOMMENDED LAND DIMENTIONS	 <p style="text-align: center;">Unit : mm</p> <table border="1" style="margin-left: auto; margin-right: auto; border-collapse: collapse;"> <thead> <tr> <th style="width: 33%;">A</th> <th style="width: 33%;">B</th> <th style="width: 33%;">C</th> </tr> </thead> <tbody> <tr> <td style="text-align: center;">1.2</td> <td style="text-align: center;">2.8</td> <td style="text-align: center;">2.0</td> </tr> </tbody> </table>	A	B	C	1.2	2.8	2.0
A	B	C					
1.2	2.8	2.0					
	<p>1. When this products are mounted on a PCB, the amount of solder used (size of fillet) can directly affect this product performance.</p> <p>2. The amount of solder applied can affect the ability of products to withstand mechanical stresses which may lead to breaking or cracking.</p> <p>Therefore, when designing land-patterns it is necessary to consider the appropriate size and configuration of the solder pads which in turn determines the amount of solder necessary to form the fillets.</p> <p>● Pattern Configurations :</p> <p>1. After this products have been mounted on the PC boards, products can be subjected to mechanical stresses in subsequent manufacturing processes. For this reason, planning pattern configurations and the position of SMD inductors should be carefully performed to minimize stress.</p> <p>2. Board separation should not be done manually, but by using the appropriate devices.</p> <p>● Considerations for Automatic Chip-Mounting</p> <p>Excessive impact load should not be imposed on the inductors when mounting onto the PC boards.</p>						

[SPECIFICATION]

[ALLOY MOLDING POWER CHOKE] (WLPSMD252010F-S)

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ITEM	CONTENTS
Reflow Soldering	<p>11. Notice for use</p> <p>1. This specification shows the quality and performance of a unit component. Before adoption, be sure to evaluate and verify the product mounting it in your product.</p> <p>2. Precautions on the use of this products.</p> <ol style="list-style-type: none"> 1). Do not apply current in excess of the rated value because this product may be high temperature. 2). Always wear static control bands to protect against ESD. 3). Keep this products away from all magnets and magnetic object. <p>3. In traffic transportation equipment (trains, cars, traffic signal equipment, etc.), medical equipment, aerospace equipment, electric heating appliances, combustion and gas equipment, disaster and crime preventive equipment, etc. in cases where it is forecast that the failure of this product gives serious damage to the human life and others, use fail-safe design and ensure safety by studying the following items.</p> <ol style="list-style-type: none"> 1). Ensure safety as the system by setting protective circuit and protective equipment. 2). Ensure safety as the system by setting such redundant circuit as do not cause danger by a signal failure. <p>4. The products are intended for use in general standard applications for general electronic equipment (AV products, household electric appliances, office equipment, information and communication equipment, etc.) ; hence, they do not take the use under the following special environments into consideration. Accordingly, the use in the following special environments, and such environmental conditions may affect the performance of the products; prior to use, verify the performance, reliability, etc. thoroughly.</p> <ol style="list-style-type: none"> 1). Use in liquids such as water, oil, chemical, and organic solvent 2). Where the product is close to a heating component, and where an inflammable such as a polyvinyl chloride wire is arranged close to the product. 3). Use in environment with large static electricity and strong electromagnetic waves. 4). Where water or water-soluble detergent is used in cleaning free soldering or in flux cleaning after soldering (Pay particular attention to soluble flux) 5). Storage in places outside the temperature range of -5 to 40°C and humidity range of 40 to 60% RH 6). Use or storage in places exposed to open-air, dusty atmosphere, and direct sunlight 7). Use or storage in places full of corrosive gases such as sea breeze, Cl₂, H₂S, NH₃, SO₂, and Nox 8). Use or storage in such a place where the product is wetted due to dew condensation. 9). Where the product is sealed or coated with resin, etc. 10). Storage over six months after our delivery (This item also applies to the case where the storage method specified in item 5) to 8) has been followed.) <p>5. In case that there are any doubt about safety problems, please inform us early and be sure to evaluate and verify the product mounting it in your product before adoption.</p>
Regulation	<ol style="list-style-type: none"> 1. This product has not been manufactured with any ozone depleting chemical controlled under the Montreal Protocol. 2. All materials used in this product are existing chemical substances recognized under "laws on examination of chemical substances and regulations of manufacturing and others." 3. All materials used in this products contain no brominated materials of PBB0s or PBBs as the flame-retardant. 4. Please contact us to obtain a notice as to whether this product has passed inspection under review criteria primarily based on Foreign Exchange and Foreign Trade Control law and appended table in the Export Control law. 5. This product complies with the RoHS Directive (Restriction of the use of certain Hazardous Substances in electrical and electronic equipment (DIRECTIVE 2002/95/EC)).